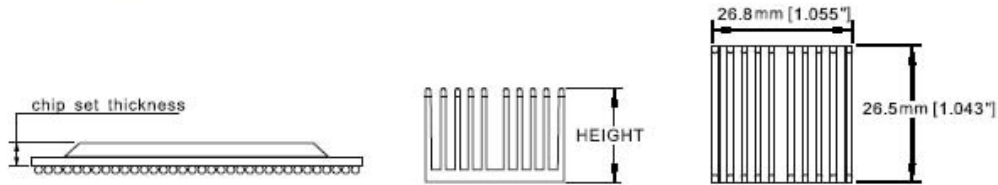


Specification BGA Heat Sink for 27x27 chip set



<p>■ Heat sink material : AL6063</p> <p>■ Finish : Black Anodize</p> <p>■ Chip set package thickness and clip color : 2.1mm~2.6mm Yellow clip 1.5mm~2.0mm Blue clip 0.9mm~1.4mm Orange clip</p> <p>■ Accessory : Clip material Plastic(94V0) Thermal pad T725 25x25mm [0.984"]</p>	Part number	Length (mm) [Inch]	Width (mm) [Inch]	Total height (mm) [Inch]	Base (mm) [Inch]	Clip color
	CMS312727-06-01					Yellow
	CMS312727-06-02	26.8 [1.055"]	26.7 [1.051"]	6.3 [0.248"]	1.7 [0.066"]	Blue
	CMS312727-06-03					Orange
	CMS312727-10-01					Yellow
	CMS312727-10-02	26.8 [1.055"]	26.5 [1.043"]	9.5 [0.374"]	1.7 [0.066"]	Blue
	CMS312727-10-03					Orange
	CMS312727-13-01					Yellow
	CMS312727-13-02	26.8 [1.055"]	26.5 [1.043"]	12.7 [0.500"]	1.7 [0.066"]	Blue
	CMS312727-13-03					Orange

Performance Heat Source(LxW):15x15mm

